10UT

1IN-[] 2

1IN+[] 3

V_{CC+}[] 4

2IN+[5

2IN-**[**6

20UT **[**7

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14 🛛 40UT

13 🛛 4IN-

12 4IN+

11 🛛 V_{CC}_

10 3IN+

9 🛛 3IN-

8 30UT

MC3303...D, N, OR PW PACKAGE MC3403...D, DB, N, NS, OR PW PACKAGE

(TOP VIEW)

- Wide Range of Supply Voltages, Single Supply ... 3 V to 36 V or Dual Supplies
- Class AB Output Stage
- True Differential Input Stage
- Low Input Bias Current
- Internal Frequency Compensation
- Short-Circuit Protection
- Designed to Be Interchangeable With Motorola MC3303, MC3403

description

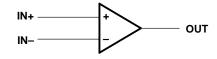
The MC3303 and the MC3403 are quadruple operational amplifiers similar in performance to the μ A741, but with several distinct advantages. They are designed to operate from a single supply over a range of voltages from 3 V to 36 V. Operation from split supplies also is possible, provided the difference between the two supplies is 3 V to 36 V. The common-mode input range includes the negative supply. Output range is from the negative supply to V_{CC} – 1.5 V. Quiescent supply currents are less than one-half those of the μ A741.

The MC3303 is characterized for operation from -40° C to 85° C, and the MC3403 is characterized for operation from 0° C to 70° C.

AVAILABLE OPTIONS												
		PACKAGE										
TA	V _{IO} MAX AT 25°C	PLASTIC SMALL OUTLINE (D, NS)	PLASTIC SHRINK SMALL OUTLINE (DB)	PLASTIC DIP (N)	PLASTIC THIN SHRINK SMALL OUTLINE (PW)							
0°C to 70°C	10 mV	MC3403D MC3403NS	MC3403DB	MC3403N	MC3403PW							
–40°C to 85°C	8 mV	MC3303D	_	MC3303N	MC3303PW							

The D package is available taped and reeled. Add R suffix to the device type (e.g., MC3403DR). The DB, NS, and PW packages are only available taped and reeled.

logic diagram (each amplifier)





Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

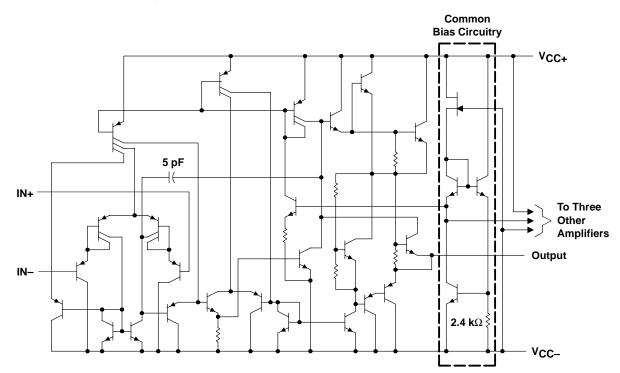
PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



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schematic (each amplifier)



Component values shown are nominal.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage (see Note 1): V _{CC+}		18 V
V _{CC}		–18 V
Supply voltage, V _{CC+} with respect to V _{CC-}		
Differential input voltage (see Note 2)		±36 V
Input voltage (see Notes 1 and 3)		±18 V
Package thermal impedance, θ_{JA} (see Note 4): D package	
	DB package	
	N package	80°C/W
	NS package	
	PW package	113°C/W
Lead temperature 1,6 mm (1/16 inch) from ca	se for 10 seconds	260°C
Storage temperature range, T _{stg}		–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. These voltage values are with respect to the midpoint between V_{CC+} and V_{CC-}.
 - 2. Differential voltages are at IN+ with respect to IN-.
 - 3. Neither input must ever be more positive than V_{CC+} or more negative than V_{CC-}.
 - 4. The package thermal impedance is calculated in accordance with JESD 51-7.



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recommended operating conditions

			MIN	MAX	UNIT
VCC	Supply voltage		5	30	V
		V _{CC+}	2.5	15	V
	Dual-supply voltage	V _{CC} -	-2.5	-15	V
т.	Operating free air temperature	MC3303	-40	85	°C
Т _А	Operating free-air temperature	MC3403	0	70	C

electrical characteristics at specified free-air temperature, V_{CC+} = 14 V, V_{CC-} = 0 V for MC3303, $V_{CC\pm}$ = ±15 V for MC3403 (unless otherwise noted)

				MC3303						
	PARAMETER	TEST CONDITION	151	MIN	TYP	MAX	MIN	TYP	MAX	UNIT
Vie	Input offect voltage	See Note 5	25°C		2	8		2	10	mV
VIO	Input offset voltage	Full range				10			12	mv
$\alpha_{\rm V_{IO}}$	Temperature coefficient of input offset voltage	See Note 5	Full range		10			10		μV/°C
l.e.	Input offset current	See Note 5	25°C		30	75		30	50	nA
10	input onset current	Full range				250			200	ΠA
$\alpha_{I_{IO}}$	Temperature coefficient of input offset current	See Note 5	Full range		50			50		pA/C
1	Innut biog ourrent	See Note 5	25°C		-0.2	-0.5		-0.2	-0.5	۸
IВ	Input bias current	See Note 5	Full range			-1			-0.8	μA
VICR	Common-mode input voltage range‡		25°C	V _{CC} to 12	V _{CC} _ to 12.5		V _{CC} - to 13	V _{CC} _ to 13.5		V
		R _L = 10 kΩ	25°C	12	12.5		±12	±13.5		
VOM	VOM voltage swing	$R_L = 2 k\Omega$	25°C	10	12		±10	±13		V
		$R_L = 2 k\Omega$	Full range	10			±10			
A. (5)	Large-signal differential	$V_{O} = \pm 10 \text{ V}, \text{ R}_{L} = 2 \text{ k}\Omega$	25°C	20	200		20	200		V/mV
AVD	voltage amplification	$V_{\rm O} = \pm 10$ V, $R_{\rm L} = 2$ KS2	Full range 15			15			V/IIIV	
B _{OM}	Maximum-output-swing bandwidth	$\label{eq:VOPP} \begin{array}{l} V_{OPP} = 20 \ V, \ A_{VD} = 1, \\ THD \leq 5\%, \ R_L = 2 \ k\Omega \end{array}$	25°C		9			9		kHz
B ₁	Unity-gain bandwidth	V_{O} = 50 mV, R _L = 10 k Ω	25°C		1			1		MHz
фт	Phase margin	$C_L = 200 \text{ pF}, R_L = 2 \text{ k}\Omega$	25°C		60°			60°		
r _i	Input resistance	f = 20 Hz	25°C	0.3	1		0.3	1		MΩ
r _o	Output resistance	f = 20 Hz	25°C		75			75		Ω
CMRR	Common-mode rejection ratio	$V_{IC} = V_{ICR}min$	25°C	70	90		70	90		dB
ksvs	Supply voltage sensitivity $(\Delta V_{IO}/\Delta V_{CC})$	$V_{CC\pm}$ = ±2.5 to ±15 V	25°C		30	150		30	150	μV/V
IOS	Short-circuit output current§		25°C	±10	±30	±45	±10	±30	±45	mA
ICC	Total supply current	No load, See Note 5	25°C		2.8	7		2.8	7	mA

[†] All characteristics are measured under open-loop conditions with zero common-mode voltage unless otherwise specified. Full range for T_A is -40°C to 85°C for MC3303, and 0°C to 70°C for MC3403.

[‡] The V_{ICR} limits are linked directly, volt-for-volt, to supply voltage; the positive limit is 2 V less than V_{CC+}.

§ Temperature and/or supply voltages must be limited to ensure that the dissipation rating is not exceeded.

NOTE 5: V_{IO} , I_{IO} , I_{IB} , and I_{CC} are defined at $V_{O} = 0$ for MC3403 and $V_{O} = 7$ V for MC3303.



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electrical characteristics, V_{CC+} = 5 V, V_{CC-} = 0 V, T_A = 25°C (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	Γ	MC3303		Ν	/IC3403		UNIT
	PARAMETER	TEST CONDITIONS [†]	MIN	TYP	MAX	MIN	TYP	MAX	UNIT
VIO	Input offset voltage	V _O = 2.5 V			10		2	10	mV
١ _Ю	Input offset current	V _O = 2.5 V			75		30	50	nA
I _{IB}	Input bias current	V _O = 2.5 V			-0.5		-0.2	-0.5	μA
	R _L = 10 kΩ	3.3	3.5		3.3	3.5			
VOM	V _{OM} Peak output voltage swing [‡]		V _{CC+} - 1.7			V _{CC+} - 1.7			V
A _{VD}	Large-signal differential voltage amplification	V_{O} = 1.7 V to 3.3 V, RL = 2 k Ω	20	200		20	200		V/mV
ks∨s	Supply-voltage sensitivity $(\Delta V_{IO} / \Delta V_{CC\pm})$	$V_{CC\pm}$ = ±2.5 V to ±15 V			150			150	μV/V
ICC	Supply current	V_{O} = 2.5 V, No load		2.5	7		2.5	7	mA
V01/V02	Crosstalk attenuation	f = 1 kHz to 20 kHz		120			120		dB

[†] All characteristics are measured under open-loop conditions with zero common-mode input voltage unless otherwise specified.

[‡]Output will swing essentially to ground.

operating characteristics, V_{CC+} = 14 V, V_{CC-} = 0 V for MC3303, V_{CC±} = ±15 V for MC3403, T_A = 25°C, A_{VD} = 1 (unless otherwise noted)

	PARAMETER		TEST CO	NDITIONS		TYP	UNIT
SR	Slew rate at unity gain	V _I = ±10 V,	C _L = 100 pF,	$R_L = 2 k\Omega$,	See Figure 1	0.6	V/µs
tr	Rise time	$\Delta V_{O} = 50 \text{ mV},$	C _L = 100 pF,	$R_L = 10 \text{ k}\Omega$,	See Figure 1	0.35	μs
t _f	Fall time	$\Delta V_{O} = 50 \text{ mV},$	C _L = 100 pF,	$R_L = 10 \text{ k}\Omega$,	See Figure 1	0.35	μs
	Overshoot factor	ΔV_{O} = 50 mV,	C _L = 100 pF,	RL = 10 kΩ,	See Figure 1	20	%
	Crossover distortion	VI(PP) = 30 mV,	V _{OPP} = 2 V,	f = 10 kHz		1	%

PARAMETER MEASUREMENT INFORMATION

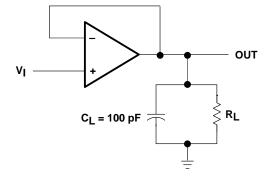
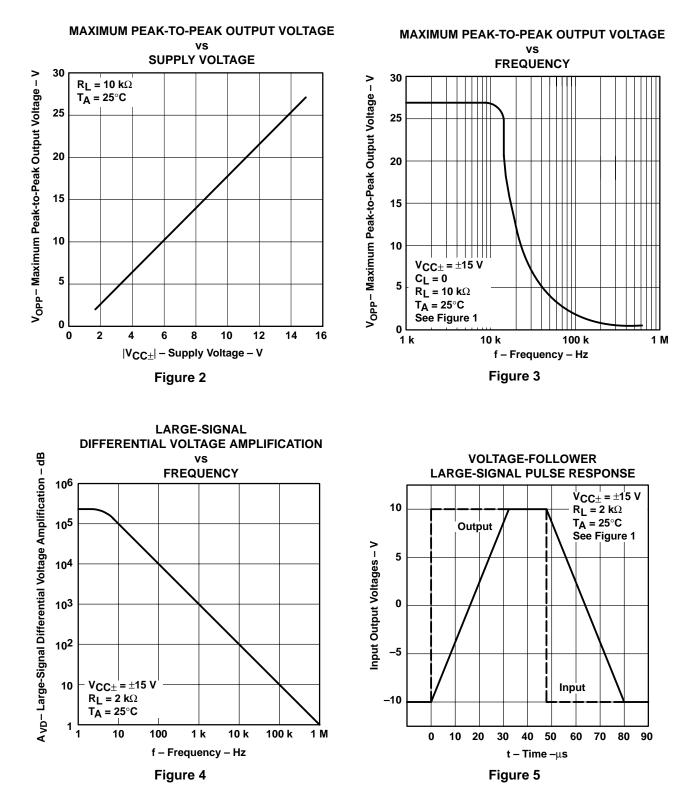


Figure 1. Unity-Gain Amplifier



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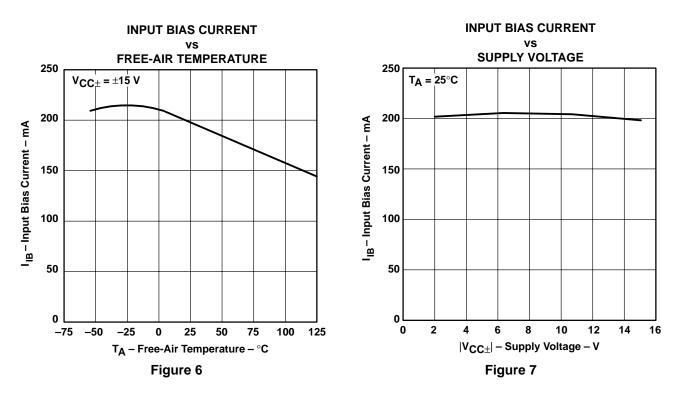


TYPICAL CHARACTERISTICS[†]

[†] Operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied.



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TYPICAL CHARACTERISTICS[†]

[†] Operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied.





PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
							(6)				
MC3303D	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	MC3303	Samples
MC3303DG4	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	MC3303	Samples
MC3303DR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	MC3303	Samples
MC3303N	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	-40 to 85	MC3303N	Samples
MC3303PW	ACTIVE	TSSOP	PW	14	90	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	M3303	Samples
MC3303PWR	ACTIVE	TSSOP	PW	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	M3303	Samples
MC3403D	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	MC3403	Samples
MC3403DR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	MC3403	Samples
MC3403N	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	MC3403N	Samples
MC3403NE4	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	MC3403N	Samples
MC3403NSR	ACTIVE	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	MC3403	Samples
MC3403PWR	ACTIVE	TSSOP	PW	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	M3403	Samples
MC3403PWRE4	ACTIVE	TSSOP	PW	14	2000	TBD	Call TI	Call TI	0 to 70		Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.



PACKAGE OPTION ADDENDUM

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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Texas

STRUMENTS

TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal												
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
MC3303DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
MC3303PWR	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
MC3403DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
MC3403DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
MC3403NSR	SO	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
MC3403PWR	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1



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PACKAGE MATERIALS INFORMATION

3-Jun-2022



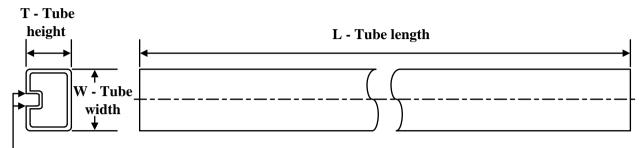
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
MC3303DR	SOIC	D	14	2500	356.0	356.0	35.0
MC3303PWR	TSSOP	PW	14	2000	356.0	356.0	35.0
MC3403DR	SOIC	D	14	2500	340.5	336.1	32.0
MC3403DR	SOIC	D	14	2500	356.0	356.0	35.0
MC3403NSR	SO	NS	14	2000	356.0	356.0	35.0
MC3403PWR	TSSOP	PW	14	2000	356.0	356.0	35.0

TEXAS INSTRUMENTS

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3-Jun-2022

TUBE



- B - Alignment groove width

*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	Τ (μm)	B (mm)
MC3303D	D	SOIC	14	50	506.6	8	3940	4.32
MC3303DG4	D	SOIC	14	50	506.6	8	3940	4.32
MC3303N	N	PDIP	14	25	506	13.97	11230	4.32
MC3303PW	PW	TSSOP	14	90	530	10.2	3600	3.5
MC3403D	D	SOIC	14	50	506.6	8	3940	4.32
MC3403N	N	PDIP	14	25	506	13.97	11230	4.32
MC3403NE4	N	PDIP	14	25	506	13.97	11230	4.32

D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.





NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
 E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



PW (R-PDSO-G14)

PLASTIC SMALL OUTLINE



A. An integration of the information o

Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.

Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.

E. Falls within JEDEC MO-153





NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- \triangle The 20 pin end lead shoulder width is a vendor option, either half or full width.



MECHANICAL DATA

PLASTIC SMALL-OUTLINE PACKAGE

0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 \bigcirc Gage Plane ₽ 0,25 7 1 1,05 0,55 0°-10° Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS ** 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G**)

14-PINS SHOWN

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



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